



#### 25A GLASS PASSIVATED BRIDGE RECTIFIER

### **Features**

- Glass Passivated Die Construction
- High Case Dielectric Strength of 2500V<sub>RMS</sub>
- Low Reverse Leakage Current
- Surge Overload Rating to 350A Peak
- Ideal for Printed Circuit Board Applications
- UL Listed Under Recognized Component Index, File Number E94661
- Lead Free Finish; RoHS Compliant (Notes 1 & 2)

## **Mechanical Data**

- Case: GBJ
- Case Material: Molded Plastic. UL Flammability Classification 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Lead Free Plating (Tin Finish).
- Polarity: Molded on Body
- Mounting: Through Hole for #6 Screw
- Mounting Torque: 5.0 in-lbs Maximum
- Marking: Type Number
- Weight: 6.6 grams (Approximate)

## **Maximum Ratings** (@ $T_A = 25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	GBJ 25005	GBJ 2501	GBJ 2502	GBJ 2504	GBJ 2506	GBJ 2508	GBJ 2510	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	200	400	600	800	1000	٧
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Average Forward Rectified Output Current (Note 3) $\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$	lo				25				Α
Non-Repetitive Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed on rated Load	I <sub>FSM</sub>				350				Α

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case (Note 5)	$R_{ heta JC}$	1.0	°C/W
Operating and Storage Temperature Range	$T_{J}$ , $T_{STG}$	-65 to +150	°C

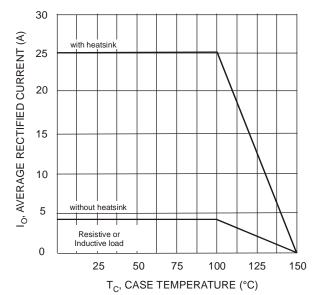
### **Electrical Characteristics** (@T<sub>A</sub> = 25°C, unless otherwise specified.)

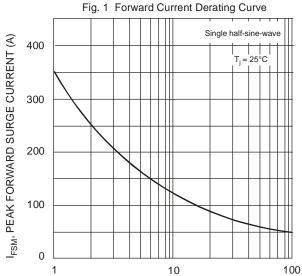
Characteristic		Symbol	Value	Unit
Forward Voltage (per element)	$@ I_F = 12.5A$	$V_{FM}$	1.05	V
Peak Reverse Current at Rated DC Blocking Voltage	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	ln ln	10 500	μΑ
I <sup>2</sup> t Rating for Fusing (t < 8.3ms)	(Note 3)	l <sup>2</sup> t	510	A <sup>2</sup> s
Typical Total Capacitance (per element)	(Note 4)	$C_{T}$	85	pF

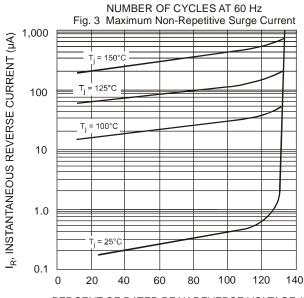
Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

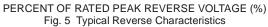
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Non-repetitive, for t > 1ms and < 8.3 ms.
- 4. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.
- 5. Thermal resistance from junction to case per element. Unit mounted on 250 x 250 x 20mm aluminum plate heat sink.

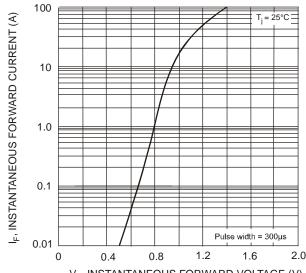












V<sub>F</sub>, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 2 Typical Forward Characteristics (per element)

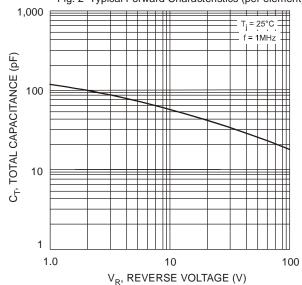


Fig. 4 Typical Total Capacitance, Per Element



## **Ordering Information** (Note 6)

Part Number	Case	Packaging
GBJ25005-F	GBJ	15/Tube
GBJ2501-F	GBJ	15/Tube
GBJ2502-F	GBJ	15/Tube
GBJ2504-F	GBJ	15/Tube
GBJ2506-F	GBJ	15/Tube
GBJ2508-F	GBJ	15/Tube
GBJ2510-F	GBJ	15/Tube

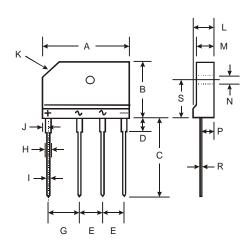
Note:

6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.





GBJ					
Dim	Min	Max			
Α	29.70	30.30			
В	19.70	20.30			
С	17.00	18.00			
D	3.80	4.20			
Е	7.30	7.70			
G	9.80	10.20			
Н	2.00	2.40			
ı	0.90	1.10			
J	2.30	2.70			
K	3.0 x 45°				
L	4.40	4.80			
M	3.40	3.80			
N	3.10	3.40			
Р	2.50	2.90			
R	0.60	0.80			
S	10.80	11.20			
All Dimensions in mm					

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance.



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